

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM643856

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	Second Lien Security Agreement		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
Resonetics, LLC		04/28/2021	Limited Liability Company: DELAWARE
Mound Laser & Photonics Center, Inc.		04/28/2021	Corporation: OHIO
Tru Tech Systems, Inc.		04/28/2021	Corporation: DELAWARE
RECEIVING PARTY DATA			
Name:	Barings Finance LLC		
Street Address:	300 South Tryon Street		
Internal Address:	Unit 2500		
City:	Charlotte		
State/Country:	NORTH CAROLINA		
Postal Code:	28202		
Entity Type:	Bank: SWITZERLAND		
PROPERTY NUMBERS Total: 2			
Property Type	Number	Word Mark	
Registration Number:	2771100	TRU TECH SYSTEMS	
Registration Number:	1644297	EZ-SURF	
CORRESPONDENCE DATA			
Fax Number:	8009144240		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
Phone:	800-713-0755		
Email:	james.murray@wolterskluwer.com, ecarrera@cahill.com		
Correspondent Name:	CT Corporation		
Address Line 1:	4400 Easton Commons Way		
Address Line 2:	Suite 125		
Address Line 4:	Columbus, OHIO 43219		
NAME OF SUBMITTER:	Elaine Carrera		
SIGNATURE:	/Elaine Carrera/		
DATE SIGNED:	05/03/2021		

OP \$65.00 2771100

Total Attachments: 11

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SECOND LIEN INTELLECTUAL PROPERTY SECURITY AGREEMENT

This **SECOND LIEN INTELLECTUAL PROPERTY SECURITY AGREEMENT** (as amended, amended and restated, supplemented or otherwise modified from time to time, the “IP Security Agreement”) dated as of April 28, 2021, is among the Persons listed on the signature pages hereof (each a “Grantor” and, collectively, the “Grantors”) and BARINGS FINANCE LLC, as collateral agent (in such capacity, together with any successor collateral agent, the “Collateral Agent”) for the Secured Parties (as defined in the Credit Agreement referred to below).

WHEREAS, RESONETICS, LLC, a Delaware limited liability company (“Borrower”) and NEW RESONETICS HOLDING CORPORATION, a Delaware corporation (“Holdings”), have entered into the Second Lien Credit Agreement dated as of April 28, 2021 (as amended, amended and restated, supplemented, replaced, refinanced or otherwise modified from time to time, the “Credit Agreement”), with the lenders and financial institutions from time to time party thereto and BARINGS FINANCE LLC, as Administrative Agent and Collateral Agent. Capitalized terms defined in the Credit Agreement or in the Second Lien Security Agreement (as defined below) and not otherwise defined herein are used herein as defined in the Credit Agreement or the Second Lien Security Agreement, as the case may be (and in the event of a conflict, the applicable definition shall be the one given to such term in the Security Agreement).

WHEREAS, pursuant to the Credit Agreement, each Grantor has executed and delivered that certain Second Lien Security Agreement dated as of April 28, 2021 (as amended, amended and restated, supplemented or otherwise modified from time to time, the “Security Agreement”), among the Grantors, the other grantors from time to time party thereto and the Collateral Agent.

WHEREAS, under the terms of the Second Lien Security Agreement, the Grantors have granted to the Collateral Agent, for the benefit of the Secured Parties, a security interest in, among other property, certain intellectual property of the Grantors, and have agreed thereunder to execute this Second Lien IP Security Agreement for recording with the USPTO and/or the USCO, as applicable.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each Grantor agrees as follows:

Section 1. Grant of Security. Each Grantor hereby pledges to the Collateral Agent (and its successors and permitted assigns), for the benefit of the Secured Parties, and each Grantor hereby grants to the Collateral Agent (and its successors and permitted assigns), for the benefit of the Secured Parties, a security interest in and continuing lien on all of such Grantor’s right, title and interest in and to the following, whether now owned or hereafter acquired or created by the undersigned (the “Collateral”):

(i) all Patents, including the patents and patent applications set forth in Schedule A hereto (the “Patent Collateral”);

(ii) all Trademarks, including the trademark and service mark registrations and applications set forth in Schedule B hereto, together with the goodwill of the business connected with the use thereof and symbolized thereby (the “Trademark Collateral”);

(iii) all Copyrights, whether registered or unregistered, including, without limitation, the copyright registrations and applications set forth in Schedule C hereto (the “Copyright Collateral”);

(iv) all reissues, divisions, continuations, continuations-in-part, extensions, renewals and reexaminations of any of the foregoing, all rights in the foregoing provided by international treaties or conventions, all rights corresponding thereto throughout the world and all other rights of any kind whatsoever of such Grantor accruing thereunder or pertaining thereto;

(v) any and all claims for damages and injunctive relief for past, present and future infringement, dilution, misappropriation, violation, misuse or breach with respect to any of the foregoing, with the right, but not the obligation, to sue for and collect such damages, or otherwise recover with respect to such claims;

(vi) any and all proceeds of, collateral for, income, royalties and other payments now or hereafter due and payable with respect to, and Supporting Obligations relating to, any and all of the foregoing or arising from any of the foregoing; and

(vii) all rights in the foregoing corresponding thereto throughout the world and all other rights of any kind whatsoever of such Grantor accruing thereunder or pertaining thereto;

provided that notwithstanding anything to the contrary contained in the foregoing clauses (i) through (vi), the security interest created hereby shall not extend to, and the term "Collateral" shall not include, any Excluded Property, including, for clarity, any United States intent-to-use trademark or service mark applications prior to the filing and acceptance of a "Statement of Use" pursuant to Section 1(d) of the Lanham Act or an "Amendment to Allege Use" pursuant to Section 1(c) of the Lanham Act with respect thereto, to the extent that, and solely during the period, if any, in which, the grant of a security interest therein would impair the validity or enforceability of any registration that issues from such intent-to-use application under applicable federal law.

Section 2. Security for Obligations. The grant of a security interest in the Collateral by each Grantor under this IP Security Agreement secures the payment of all Secured Obligations of such Grantor. Without limiting the generality of the foregoing, this IP Security Agreement secures, as to each Grantor, the payment of all amounts that constitute part of the Secured Obligations that would be owed by such Grantor to any Secured Party under the Loan Documents but for the fact that they are unenforceable or not allowable due to the existence of a bankruptcy, or reorganization or similar proceeding involving a Loan Party.

Section 3. Recordation. Each Grantor authorizes and requests that the Register of Copyrights, the Commissioner for Patents and the Commissioner for Trademarks, as applicable, record this IP Security Agreement.

Section 4. Execution in Counterparts. This Second Lien IP Security Agreement may be executed in any number of counterparts, each of which when so executed shall be deemed to be an original and all of which taken together shall constitute one and the same agreement.

Section 5. Grants, Rights and Remedies. This Second Lien IP Security Agreement has been entered into in conjunction with the provisions of the Security Agreement. Each Grantor does hereby acknowledge and confirm that the grant of the security interest hereunder to, and the rights and remedies of, the Collateral Agent with respect to the Collateral are more fully set forth in the Second Lien Security Agreement, the terms and provisions of which are incorporated herein by reference as if fully set forth herein. In the event of any conflict between the terms of this Second Lien IP Security Agreement and the

terms of the Second Lien Security Agreement, the terms of the Second Lien Security Agreement shall govern.

Section 6. Governing Law; Jurisdiction; Etc.

(a) THIS SECOND LIEN IP SECURITY AGREEMENT SHALL BE GOVERNED BY, AND CONSTRUED IN ACCORDANCE WITH, THE LAW OF THE STATE OF NEW YORK WITHOUT GIVING EFFECT TO THE CONFLICTS OF LAWS PRINCIPLES THEREOF, BUT INCLUDING SECTION 5-1401 OF THE NEW YORK GENERAL OBLIGATIONS LAW.

(b) EACH PARTY HERETO IRREVOCABLY AND UNCONDITIONALLY SUBMITS, FOR ITSELF AND ITS PROPERTY, TO THE EXCLUSIVE JURISDICTION OF THE COURTS OF THE STATE OF NEW YORK SITTING IN NEW YORK CITY IN THE BOROUGH OF MANHATTAN AND OF THE UNITED STATES DISTRICT COURT FOR THE SOUTHERN DISTRICT OF NEW YORK SITTING IN THE BOROUGH OF MANHATTAN, AND ANY APPELLATE COURT FROM ANY THEREOF, IN ANY ACTION OR PROCEEDING ARISING OUT OF OR RELATING TO THIS SECOND LIEN IP SECURITY AGREEMENT, OR FOR RECOGNITION OR ENFORCEMENT OF ANY JUDGMENT, AND EACH OF THE PARTIES HERETO IRREVOCABLY AND UNCONDITIONALLY AGREES THAT ALL CLAIMS IN RESPECT OF ANY SUCH ACTION OR PROCEEDING MAY BE HEARD AND DETERMINED IN SUCH NEW YORK STATE COURT OR, TO THE FULLEST EXTENT PERMITTED BY APPLICABLE LAW, IN SUCH FEDERAL COURT. EACH OF THE PARTIES HERETO AGREES THAT A FINAL JUDGMENT IN ANY SUCH ACTION OR PROCEEDING SHALL BE CONCLUSIVE AND MAY BE ENFORCED IN OTHER JURISDICTIONS BY SUIT ON THE JUDGMENT OR IN ANY OTHER MANNER PROVIDED BY LAW. NOTHING IN THIS SECOND LIEN IP SECURITY AGREEMENT SHALL AFFECT ANY RIGHT THAT THE COLLATERAL AGENT, ANY LENDER OR ANY L/C ISSUER MAY OTHERWISE HAVE TO BRING ANY ACTION OR PROCEEDING RELATING TO THIS SECOND LIEN IP SECURITY AGREEMENT OR THE RECOGNITION OR ENFORCEMENT OF ANY JUDGMENT AGAINST ANY LOAN PARTY OR ITS PROPERTIES IN THE COURTS OF ANY JURISDICTION.

(c) EACH PARTY HERETO IRREVOCABLY AND UNCONDITIONALLY WAIVES, TO THE FULLEST EXTENT PERMITTED BY APPLICABLE LAW, ANY OBJECTION THAT IT MAY NOW OR HEREAFTER HAVE TO THE LAYING OF VENUE OF ANY ACTION OR PROCEEDING ARISING OUT OF OR RELATING TO THIS IP SECURITY AGREEMENT IN ANY COURT REFERRED TO IN CLAUSE (b) OF THIS SECTION 6. EACH OF THE PARTIES HERETO HEREBY IRREVOCABLY WAIVES, TO THE FULLEST EXTENT PERMITTED BY APPLICABLE LAW, THE DEFENSE OF AN INCONVENIENT FORUM TO THE MAINTENANCE OF SUCH ACTION OR PROCEEDING IN ANY SUCH COURT.

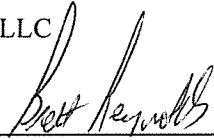
(d) EACH PARTY HERETO IRREVOCABLY CONSENTS TO SERVICE OF PROCESS IN THE MANNER PROVIDED FOR NOTICES IN SECTION 10.02 OF THE CREDIT AGREEMENT. NOTHING IN THIS SECOND LIEN IP SECURITY AGREEMENT WILL AFFECT THE RIGHT OF ANY PARTY HERETO TO SERVE PROCESS IN ANY OTHER MANNER PERMITTED BY APPLICABLE LAW.

(c) EACH PARTY TO THIS SECOND LIEN IP SECURITY AGREEMENT HEREBY EXPRESSLY WAIVES ANY RIGHT TO TRIAL BY JURY OF ANY CLAIM, DEMAND, ACTION OR CAUSE OF ACTION ARISING UNDER THIS SECOND LIEN IP SECURITY AGREEMENT OR IN ANY WAY CONNECTED WITH OR RELATED OR INCIDENTAL TO THE DEALINGS OF THE PARTIES HERETO OR ANY OF THEM WITH RESPECT TO THIS SECOND LIEN IP SECURITY AGREEMENT, OR THE TRANSACTIONS RELATED THERETO, IN EACH CASE WHETHER NOW EXISTING OR HEREAFTER ARISING, AND WHETHER FOUNDED IN CONTRACT OR TORT OR OTHERWISE; AND EACH PARTY HEREBY AGREES AND CONSENTS THAT ANY SUCH CLAIM, DEMAND, ACTION OR CAUSE OF ACTION SHALL BE DECIDED BY COURT TRIAL WITHOUT A JURY, AND THAT ANY PARTY TO THIS SECOND LIEN IP SECURITY AGREEMENT MAY FILE AN ORIGINAL COUNTERPART OR A COPY OF SECTION 10.17 OF THE CREDIT AGREEMENT WITH ANY COURT AS WRITTEN EVIDENCE OF THE CONSENT OF THE SIGNATORIES HERETO TO THE WAIVER OF THEIR RIGHT TO TRIAL BY JURY.

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IN WITNESS WHEREOF, each Grantor and the Collateral Agent have caused this First Lien IP Security Agreement to be duly executed and delivered by its officer thereunto duly authorized as of the date first written above.


RESONETICS, LLC

By: 

Name: Brett Reynolds

Title: Chief Financial Officer

MOUND LASER & PHOTONICS CENTER, INC.

By: 

Name: Brett Reynolds

Title: Chief Financial Officer

TRU TECH SYSTEMS, INC.

By: 

Name: Brett Reynolds

Title: Chief Financial Officer

[Signature Page to Second Lien Intellectual Property Security Agreement]

TRADEMARK
REEL: 007277 FRAME: 0628

BARINGS FINANCE LLC,
as Collateral Agent

By: 
Name: Sunny Khorana
Title: Managing Director

SCHEDULE A

PATENTS

U.S. PATENTS

Title	Owner	Patent No.	Issue Date
Method and apparatus for laser micromachining a conical surface	Resonetics, LLC	US7812280 B2	10-12-2010
Laser machining system and method for machining three-dimensional objects from a plurality of directions	Resonetics, LLC	US9132585 B2	9-15-2015
Wall thickness compensation during laser orifice drilling	Resonetics, LLC	US9694446 B2	7-4-2017
Precision laser ablation	Resonetics, LLC	US8772671 B2	7-8-2014
Laser machining system and method for machining three-dimensional objects from a plurality of directions	Resonetics, LLC	US9511448 B2	12-6-2016
Apparatus for minimizing a heat affected zone during laser micro-machining	Resonetics, LLC	US8278590 B2	10-2-2012
Methods and apparatuses for homogenizing light	Resonetics, LLC	US7210820 B2	5-1-2007
CHEMICALLY SHARPENING BLADES	MOUND LASER & PHOTONICS CENTER, INC.	US 9844888 B2	12-19-2017
CHEMICALLY SHARPENED BLADES	MOUND LASER & PHOTONICS CENTER, INC.	US 10500748 B2	12-10-2019
METALLIZED COMPONENTS AND SURGICAL INSTRUMENTS	MOUND LASER & PHOTONICS CENTER, INC.	US 10625083 B2	4-21-2020
CHEMICALLY SHARPENING BLADES	MOUND LASER & PHOTONICS CENTER, INC.	US 10478984 B2	11-19-2019
METALLIZED COMPONENTS AND	MOUND LASER & PHOTONICS CENTER,	US 10925663 B2	2-23-2021

Title	Owner	Patent No.	Issue Date
SURGICAL INSTRUMENTS	INC.		

U.S. Patent Applications

Title	Owner	Serial No./ Filing Date	Publication No./ Publication Date
CERAMIC DOTS PROCESS	MOUND LASER & PHOTONICS CENTER, INC.	16/512,178 7-15-2019	20210017093 1-21-2021
CHEMICALLY SHARPENING BLADES	MOUND LASER & PHOTONICS CENTER, INC.	16/687,588 11-18-2019	20200139567 5-07-2020
NEEDLE WITH ROUNDED EDGE	MOUND LASER & PHOTONICS CENTER, INC.	16/792,039 2-14-2020	20200180180 6-11-2020
METALLIZED COMPONENTS AND SURGICAL INSTRUMENTS	MOUND LASER & PHOTONICS CENTER, INC.	16/818,972 3-13-2020	20200215334 7-09-2020

SCHEDULE B**TRADEMARKS**

Mark	App. No.	Filing Date	Reg. No.	Reg. Date	Owner
TRU TECH SYSTEMS	76/420078	6/13/02	2,771,100	10/7/03	Tru Tech Systems, Inc.
EZ-SURF	74/064518	5/31/90	1,644,297	5/14/91	Tru Tech Systems, Inc.

SCHEDULE C

COPYRIGHTS

Title	Reg. No.	Reg. Date	Owner
3 axis machine software.	TX0006267839	10/26/05	Tru Tech Systems, Inc.
4 axis machine software.	TX0006254245	10/26/05	Tru Tech Systems, Inc.
EZ surf machine software.	TX0006257580	10/26/05	Tru Tech Systems, Inc.
Inspect machine software.	TX0006254244	10/26/05	Tru Tech Systems, Inc.
OD grinder software.	TX0006256558	10/26/05	Tru Tech Systems, Inc.
True delta pick and place software.	TX0004802740	6/22/98	Tru Tech Systems
RESONETICS EXCIMER LASER TECHNOLOGY.	TX0002576542	5/16/89	Resonetics, Inc.